High Current Ferrite Chip Bead(Lead Free)

HCB1005KF-121T15

REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN
1.0	13/06/06	變更可靠度條件	楊祥忠	羅培君	張嘉玛
2.0	14/01/24	變更電鍍錫層厚度 3.0um min.=>3.5um min.	楊祥忠	羅培君	張嘉珰
3.0	14/03/20	修正包裝帶圖示	楊祥忠	羅培君	張嘉玛
4.0	14/08/01	變更 Reflow 圖示	楊祥忠	羅培君	張嘉珰
4.1	14/08/01	修正包裝帶尺寸	楊祥忠	羅培君	張嘉珰
5.0	16/01/26	增訂可靠度 Thermal shock: (Bead) Step3:125±2℃ 30±5min	楊祥忠	詹偉特	張嘉珰
6.0	17/02/16	修訂 Recommended PC Board Pattern	楊祥忠	詹偉特	張嘉珰
備					
註					

TAI-TECH TBM01-170700492

High Current Ferrite Chip Bead(Lead Free)

HCB1005KF-121T15

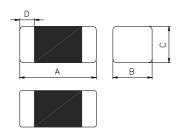
Certificate

Green Partner

1.Features

- 1. Monolithic inorganic material construction.
- 2. Closed magnetic circuit avoids crosstalk.
- 3. Suitable for reflow soldering.
- 4. Shapes and dimensions follow E.I.A. spec.
- 5. Available in various sizes.
- 6. Excellent solder ability and heat resistance.
- 7. High reliability.
- 8. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
- 9. Low DC resistance structure of electrode to prevent wasteful electric power consumption.

2.Dimensions



A 1.00	0±0.10
B 0.50	0±0.10
C 0.50	0±0.10
D 0.25	5±0.10

Units: mm

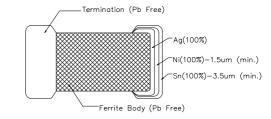
3.Part Numbering



D: Impedance E: Packaging T=Taping and Reel, B=Bulk(Bags)

121=120Ω

F: Rated Current

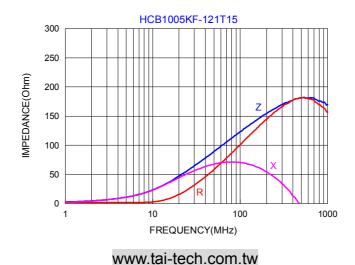


4. Specification

Tai-Tech Part Number	Impedance (Ω)	Test Frequency (Hz)	DC Resistance (Ω) max.	Rated Current (mA) max.
HCB1005KF-121T15	120±25%	60mV/100M	0.095	1500

- Rated current: based on temperature rise test
- In compliance with EIA 595

Impedance-Frequency Characteristics



TAI-TECH TBM01-170700492 P3.

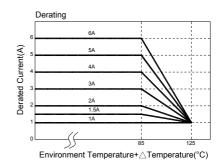
5. Reliability and Test Condition

Item			Performance	9			Те	st Cond	dition	
Series No.	FCB	FCM	<mark>нсв</mark>	GHB	FCA					
Operating Temperature		(Inclu	-40~+125°C ding self-tempera	ature rise)						
Transportation Storage Temperature			-40~+125℃ (on board)			For long			ons, please	see the
Impedance (Z)	Pofor to stand	dard electrical o	haracteristics list			Agilent42 Agilent E Agilent42 Agilent10	287			
DC Resistance	_ Refer to start	iaru electricai c	ilalacielistics list			Agilent 4				
Rated Current						DC Power Range some ris	ted Curi		ements, the	re will be
Temperature Rise Test	Rated Current < 1	-	(2. Tempe therm	erature i ometer.		by digital si	
Life test		vithin±15%of ini				times.(II Reflow F Tempera Applied of Duration Measure for 24±2	PC/JED Profiles) Iture: 12 current: : 1000± id at ro hrs.	EC J-STD 25±2°C rated curro 12hrs. om tempe	erature afte	sification
Load Humidity	Q : Shall not	•	tial value. cification value. value and shall no	ot exceed the spe	ecification value	times.(II Reflow F Humidity Tempera Duration current.	PC/JED Profiles) r: 85±2% ture: 85 : 1000	EC J-STD 6R.H. 5±2℃. hrs Min.	ugh IR refl -020D Clas with 100 erature afte	sification
Thermal shock	Inductance: w Q : Shall not	vithin±15%of ini vithin±10%of ini exceed the spe		ot exceed the spe	ecification value	times.(II Reflow F Condition Step1: -4 Step2: 2: Step3: + Number	PC/JED Profiles) In for 1 of 10±2°C 5±2°C 125±2°C of cycle and at ro	eycle 30±5 ≤ 0.5n 30±5m 30±5m s: 500	nin	sification
Vibration	Inductance : Q : Shall not	within±15% of i within±10% of i exceed the spe		ot exceed the spe	ecification value	times.(II Reflow F Oscillation minutes Equipment Total Am	PC/JED Profiles) on Freq ent: Vi plitude: Time: 1	EC J-STD uency: 10 bration chi 1.52mm±1 2 hours(20		sification
Bending	Inductance : Q : Shall not	within±10% of i within±10% of i exceed the spe		ot exceed the spe	ecification value	following >=0805in <0805in Bending >=0805in <0805in	dimens nch(201 ch(2012 depth: nch(201 ch(2012	sions: 2mm):40x	m	
	Appearance :					Test co	Peak	Normal		Velocity
Shock	Inductance : v	within±10% of i	nitial value			Туре	Value (g's)	duration (D) (ms)	Wave form	change (Vi)ft/sec
			cification value. value and shall no	ot exceed the spe	ecification value	SMD Lead	50 50	11	Half-sine Half-sine	11.3
Solderability	More than 95%	% of the termina	al electrode shoul	d be covered with	n solder.	Preheat: Solder: S Solder to Flux for I	150°C,6 6n96.5% emperat ead free omplete	60sec. 6-Ag3%-Ci ure: 245±5 e: Rosin. 9	u0.5% 5℃	

Item	Performance		Те	st Con	dition
			Number of heat	cycles: 1	
Resistance to Soldering	Appearance: No damage. Impedance: within±15% of initial value		Temperature (°C)	Time (s)	Temperature ramp/immersion and emersion rate
Heat	Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value				25mm/s ±6 mm/s
			Depth: complete	ely cover to	he termination
Terminal strength	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	substrate press tool shear force	times.(IPC/JED Reflow Profiles) Component mo >0805inch(2012 <=0805inch(201 to the side of a shall be applied	unted on a mm):1kg 2mm):0.5 device bei d for 60 + oplied grad	ing tested. This force 1 seconds. Also the dually as not to shock

**Derating Curve

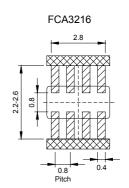
For the ferrite chip bead which withstanding current over 1.5A, as the operating temperature over $85^{\circ}\mathbb{C}$, the derating current information is necessary to consider with. For the detail derating of current, please refer to the Derated Current vs. Operating Temperature curve.



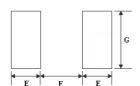
6. Soldering and Mounting

6-1. Recommended PC Board Pattern

			Pattern w Sold					
Series	Туре	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)	F(mm)	G(mm)
	0603	0.6±0.03	0.30±0.03	0.30±0.03	0.15±0.05	0.35	0.30	0.40
FCB	<mark>1005</mark>	<mark>1.0±0.10</mark>	<mark>0.50±0.10</mark>	0.50±0.10	0.25±0.10	<mark>0.50</mark>	<mark>0.40</mark>	<mark>0.60</mark>
FCM	1608	1.6±0.15	0.80±0.15	0.80±0.15	0.30±0.20	0.80	0.85	0.95
HCB	2012	2.0±0.20	1.25±0.20	0.85±0.20	0.50±0.30	1.05	1.00	1.45
GHB	2012	2.0±0.20	1.25±0.20	1.25±0.20	0.50±0.30	1.05	1.00	
FCI FHI	3216	3.2±0.20	1.60±0.20	1.10±0.20	0.50±0.30	1.05	2.20	1.80
FCH	3225	3.2±0.20	2.50±0.20	1.30±0.20	0.50±0.30	1.05	2.20	2.70
HCI	4516	4.5±0.20	1.60±0.20	1.60±0.20	0.50±0.30	1.05	3.30	1.80
	4532	4.5±0.20	3.20±0.20	1.50±0.20	0.50±0.30	1.05	3.30	3.40



Land
Solder Resist



PC board should be designed so that products can prevent damage from mechanical stress when warping the board.

6-2. Soldering

Mildly activated rosin fluxes are preferred. The terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

Note.

If wave soldering is used ,there will be some risk.

Re-flow soldering temperatures below 240 degrees, there will be non-wetting risk

TAI-TECH TBM01-170700492 P5.

6-2.1 Lead Free Solder re-flow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. (Refered to J-STD-020C)

6-2.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. If a soldering iron must be employed the following precautions are recommended. for Iron Soldering in Figure 2.

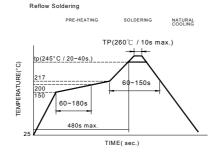
• Preheat circuit and products to 150℃

• 350°C tip temperature (max)

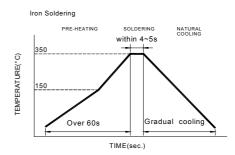
Never contact the ceramic with the iron tip

• 1.0mm tip diameter (max)

- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 4~5sec.



Reflow times: 3 times max Fig.1

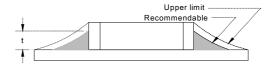


Iron Soldering times: 1 times max Fig.2

6-2.3 Solder Volume:

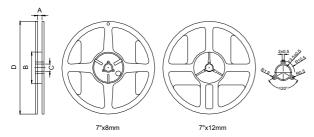
Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance. Solder shall be used not to be exceed as shown in right side:

Minimum fillet height = soldering thickness + 25% product height



7. Packaging Information

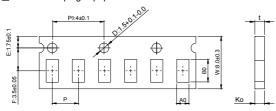
7-1. Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	9.0±0.5	<mark>60±2</mark>	13.5±0.5	<mark>178±2</mark>
7"x12mm	13.5±0.5	60±2	13.5±0.5	178±2

7-2.1 Tape Dimension / 8mm

■Material of taping is paper



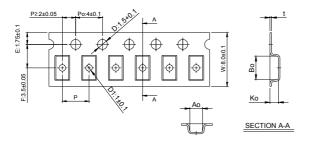
E:1.75±0.1	P22±0.1	W:8.0±0.1	t
F:3.5	Р	_	Ко

Size	•	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)
06030	3	0.70±0.06	0.40±0.06	0.45max	2.0±0.05	0.45max
<mark>10050</mark>	5	1.12±0.03	<mark>0.62±0.03</mark>	<mark>0.60±0.03</mark>	<mark>2.0±0.05</mark>	<mark>0.60±0.03</mark>

Ī	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)
	160808	1.80±0.05	0.96+0.05/-0.03	0.95±0.05	4.0±0.10	0.95±0.05
	201209	2.10±0.05	1.30±0.05	0.95±0.05	4.0±0.10	0.95±0.05

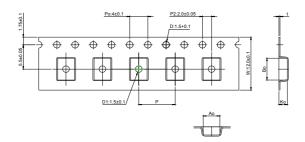
TAI-TECH TBM01-170700492 P6.

■Material of taping is plastic



Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)	D1(mm)
201212	2.10±0.10	1.28±0.10	1.28±0.10	4.0±0.10	0.22±0.05	1.0±0.10
321611	3.35±0.10	1.75±0.10	1.25±0.10	4.0±0.10	0.23±0.05	1.0±0.10
322513	3.42±0.10	2.77±0.10	1.55±0.10	4.0±0.10	0.22±0.05	1.0±0.10
321609	3.40±0.10	1.77±0.10	1.04±0.10	4.0±0.10	0.22±0.05	1.0±0.10

7-2.2 Tape Dimension / 12mm

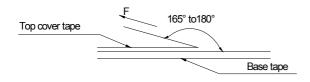


Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)	D1(mm)
451616	4.70±0.10	1.75±0.10	1.75±0.10	4.0±0.10	0.24±0.05	1.5±0.10
453215	4.70±0.10	3.45±0.10	1.60±0.10	8.0±0.10	0.24±0.05	1.5±0.10

7-3. Packaging Quantity

Chip Size	453215	451616	322513	321611	321609	201212	201209	160808	<mark>100505</mark>	060303
Chip / Reel	1000	2000	2500	3000	3000	2000	4000	4000	<mark>10000</mark>	15000
Inner box	4000	8000	12500	15000	15000	10000	20000	20000	<mark>50000</mark>	75000
Middle box	20000	40000	62500	75000	75000	50000	100000	100000	<mark>250000</mark>	375000
Carton	40000	80000	125000	150000	150000	100000	200000	200000	<mark>500000</mark>	750000

7-4. Tearing Off Force



The force for tearing off cover tape is 15 to 60 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed	
(℃)	(%)	(hPa)	mm/min	
5~35	45~85	860~1060	300	

Application Notice

Storage Conditions(component level)

To maintain the solder ability of terminal electrodes:

- 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 2. Temperature and humidity conditions: Less than 40°C and 60% RH.
- 3. Recommended products should be used within 12 months from the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.



Test Report

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日期(Date): 2016/12/12

頁數(Page): 1 of 15

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(臺慶精密電子(昆山)有限公司 / TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)

(慶邦電子元器件 (泗洪) 有限公司 / TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

桃園市楊梅區幼獅工業區幼四路1號 (NO. 1, YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN CITY, TAIWAN, R. O. C.)

(江蘇省昆山市篷朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)) (中國,江蘇省,宿遷市,泗洪縣,經濟開發區杭州路南側,建設北路東側 / THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD, ECONOMIC DEVELOPMENT ZONE, SIHONG COUNTY, SUQIANCITY, JIANGSU PROVINCE, P. R., CHINA)

以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by/on behalf of the applicant as):

樣品名稱(Sample Description)

FERRITE CHIP BEAD INDUCTOR ARRAY MCF MCM YMV SERIES

樣品型號(Style/Item No.)

FERRITE CHIP BEAD INDUCTOR ARRAY MCF MCM YMV SERIES

收件日期(Sample Receiving Date)

2016/12/06

測試期間(Testing Period)

2016/12/06 TO 2016/12/12

测试结果(Test Results) : 請見下一頁 (Please refer to next pages).



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Test Report

號碼(No.): CE/2016/C0807

日期(Date): 2016/12/12

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測試結果(Test Results)

測試部位(PART NAME)No.1

整體混測 (MIXED ALL PARTS)

測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値	結果 (Result)
(lest items)	(01111)	(method)	(MDL)	No. 1
鍋 / Cadmium (Cd)	mg/kg	参考IEC 62321-5 (2013),以感應耦合 電漿原子發射光譜儀檢測. / With	2	n. d.
鉛 / Lead (Pb)	mg/kg	reference to IEC 62321-5 (2013) and performed by ICP-AES.	2	n, d.
汞 / Mercury (Hg)	mg/kg	參考IEC 62321-4 (2013),以感應耦合 電漿原子發射光譜儀檢測. / With reference to IEC 62321-4 (2013) and performed by ICP-AES.	2	n. d.
六價鉻 / Hexavalent Chromium Cr(VI)	mg/kg	参考IEC 62321 (2008),以UV-VIS檢 測. / With reference to IEC 62321 (2008) and performed by UV-VIS.	2	n. d.
绨 / Antimony (Sb)	mg/kg	参考US EPA 3052 (1996),以感應耦合電漿原子發射光譜儀檢測. / With reference to US EPA 3052 (1996). Analysis was performed by ICP-AES.	2	n. d.
神 / Arsenic (As)	mg/kg	参考US EPA 3052 (1996),以感應耦合電漿原子發射光譜儀檢測. / With reference to US EPA 3052 (1996). Analysis was performed by ICP-AES.	2	n. d.
鈹 / Beryllium (Be)	mg/kg	参考US EPA 3052 (1996),以感應耦合電漿原子發射光譜儀檢測. / With reference to US EPA 3052 (1996). Analysis was performed by ICP-AES.	2	n. d.

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測試項目 (Test Items)	單位 (Unit)	测試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
多溴聯苯總和 / Sum of PBBs	mg/kg		. – .	n. d.
一溴聯苯 / Monobromobiphenyl	mg/kg		5	n. d.
二溴聯苯 / Dibromobiphenyl	mg/kg	1	5	n. d.
三溴聯苯 / Tribromobiphenyl	mg/kg]	5	n. d.
四溴聯苯 / Tetrabromobiphenyl	mg/kg	1	5	n. d.
五溴聯苯 / Pentabromobiphenyl	mg/kg	· · · · · · · · · · · · · · · · · · ·	5	n. d.
六溴聯苯 / Hexabromobiphenyl	mg/kg] · [5	n. d.
七溴聯苯 / Heptabromobiphenyl	mg/kg]	5	n. d.
八溴聯苯 / Octabromobiphenyl	mg/kg]	5	n. d.
九溴聯苯 / Nonabromobiphenyl	mg/kg	多考IEC 62321-6 (2015),以氣相層析	5	n. d.
十溴聯苯 / Decabromobiphenyl	mg/kg	/質譜儀檢測. / With reference to	5	n. d.
多溴聯苯醚總和 / Sum of PBDEs	mg/kg	IEC 62321-6 (2015) and performed	_	n. d.
一溴聯苯醚 / Monobromodiphenyl ether	mg/kg	by GC/MS.	5	n. d.
二溴聯苯醚 / Dibromodiphenyl ether	mg/kg		5	n. d.
三溴聯苯醚 / Tribromodiphenyl ether	mg/kg		5	n. d.
四溴聯苯醚 / Tetrabromodiphenyl ether	mg/kg	· .	5	n, d.
五溴聯苯醚 / Pentabromodiphenyl ether	mg/kg		5	n. d.
六溴聯苯醚 / Hexabromodiphenyl ether	mg/kg	·	5	n. d.
七溴聯苯醚 / Heptabromodiphenyl ether	mg/kg	.[5	n. d.
八溴聯苯醚 / Octabromodiphenyl ether	mg/kg		5	n. d.
九溴聯苯醚 / Nonabromodiphenyl ether	mg/kg		. 5	n. d.
十溴聯苯醚 / Decabromodiphenyl ether	mg/kg	·	5	n. d.
鄰苯二甲酸丁苯甲酯 / BBP (Butyl	mg/kg	參考IEC 62321-8/CD (2013),以氣相	50	n. d.
Benzyl phthalate) (CAS No.: 85-68-7)		多考1EC 02321-0/CD (2013), 以来相 層析儀/質譜儀檢測. / With reference to IEC 62321-8/CD		
鄰苯二甲酸二丁酯 / DBP (Dibutyl	mg/kg	(2013). Analysis was performed by	50	n. d.
phthalate) (CAS No.: 84-74-2)	· · · · · · · · · · · · · · · · · · ·	GC/MS.	· .	

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測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
鄰苯二甲酸二 (2-乙基己基)酯 / DEHP (Di- (2-ethylhexyl) phthalate) (CAS No.: 117-81-7)	mg/kg		50	n. d.
鄰苯二甲酸二異丁酯 / DIBP (Di- isobutyl phthalate) (CAS No.: 84-69- 5)	mg/kg		50	n. d.
鄉苯二甲酸二異癸酯 / DIDP (Di- isodecyl phthalate) (CAS No.: 26761- 40-0; 68515-49-1)	mg/kg	参考IEC 62321-8/CD (2013),以氣相 層析儀/質譜儀檢測. / With	50	n. d.
鄰苯二甲酸二異壬酯 / DINP (Di- isononyl phthalate) (CAS No.: 28553- 12-0; 68515-48-0)	mg/kg	reference to IEC 62321-8/CD (2013). Analysis was performed by GC/MS.	50	n. d.
鄰苯二甲酸二正辛酯 / DNOP (Di-n-octyl phthalate) (CAS No.: 117-84-0)	mg/kg		50	n. d.
鄰苯二甲酸二正己酯 / DNHP (Di-n-hexyl phthalate) (CAS No.: 84-75-3)	mg/kg		50	n. d.
鄰苯二甲酸二戊酯 / DNPP (Di-n-pentyl phthalate) (CAS No.: 131-18-0)	mg/kg		50	n. d.
六溴環十二烷及所有主要被辨別出的異構物 / Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α - HBCDD, β - HBCDD, γ - HBCDD) (CAS No.: 25637-99-4 and 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8))	mg/kg	参考IEC 62321 (2008),以氣相層析/ 質譜儀檢測. / With reference to IEC 62321 (2008). Analysis was performed by GC/MS.	5	n. d.

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測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1
鹵素 / Halogen				110.1
鹵素(氟)/ Halogen-Fluorine (F) (CAS No.: 14762-94-8)	mg/kg		50	n. d.
鹵素(氯)/ Halogen-Chlorine (C1) (CAS No.: 22537-15-1)	mg/kg	参考BS EN 14582 (2007),以離子層析 儀分析. / With reference to BS EN	50	n. d.
鹵素(溴)/ Halogen-Bromine (Br) (CAS No.: 10097-32-2)	mg/kg	14582 (2007). Analysis was performed by IC.	50	n. d.
鹵素(碘)/ Halogen-Iodine (I) (CAS No.: 14362-44-8)	mg/kg		50	n. d.
全氟辛烷磺酸 / Perfluorooctane sulfonates (PFOS-Acid, Metal Salt, Amide)	mg/kg	参考US EPA 3550C (2007),以液相層析/質譜儀檢測./ With reference to US EPA 3550C (2007). Analysis was performed by LC/MS.	10	n. d.
全氟辛酸 / PFOA (CAS No.: 335-67-1)	mg/kg	参考US EPA 3550C (2007),以液相層析/質譜儀檢測./ With reference to US EPA 3550C (2007). Analysis was performed by LC/MS.	10	n. d.
聚氯乙烯 / PVC	**	以紅外光譜分析及焰色法檢測. / Analysis was performed by FTIR and FLAME Test.		Negative

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備註(Note):

- 1. mg/kg = ppm ; 0.1wt% = 1000ppm
- 2. n.d. = Not Detected (未檢出)
- 3. MDL = Method Detection Limit (方法偵測極限值)
- 4. "-" = Not Regulated (無規格值)
- 5. **= Qualitative analysis (No Unit) 定性分析(無單位)
- 6. Negative = Undetectable 陰性(未偵測到); Positive = Detectable 陽性(已偵測到)
- 7. 樣品的測試是基於申請人要求混合測試,報告中的混合測試結果不代表其中個別單一材質的含量. (The samples was/were analyzed on behalf of the applicant as mixing sample in one testing. The above results was/were only given as the informality value.)

PFOS参考資訊(Reference Information): 持久性有機污染物 POPs - (EU) 757/2010

PFOS濃度在物質或製備中不得超過0.001%(10ppm),在半成品、成品或零部件中不得超過0.1%(1000ppm),在紡織品或塗 層材料中不得超過1µg/m2。

(Outlawing PFOS as substances or preparations in concentrations above 0.001% (10ppm), in semi-finished products or articles or parts at a level above 0.1%(1000ppm), in textiles or other coated materials above $1\mu g/m^2$.)

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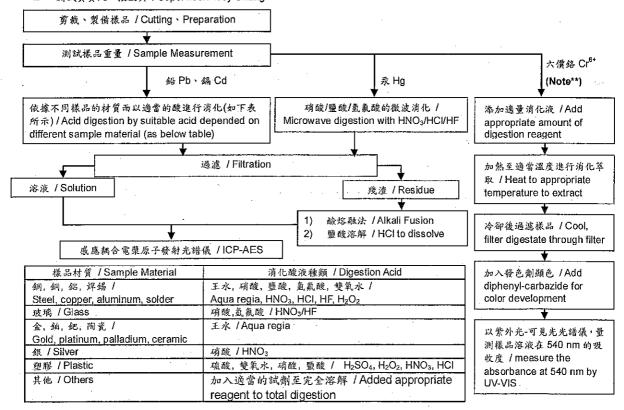
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<u> 重金屬流程圖 / Analytical flow chart of Heavy M</u>etal (IEC 62321)

根據以下的流程圖之條件,樣品已完全溶解。(六價鉻測試方法除外)/

These samples were dissolved totally by pre-conditioning method according to below flow chart. (Cr6+ test method excluded)

- 測試人員:王志瑋 / Technician: JR Wang
- 測試負責人:張啟興 / Supervisor: Troy Chang



Note**: (1) 針對非金屬材料加入鹼性消化液,加熱至 90~95℃ 萃取. / For non-metallic material, add alkaline digestion reagent and heat to 90~95℃.

(2) 針對金屬材料加入純水,加熱至沸腾萃取. / For metallic material, add pure water and heat to boiling

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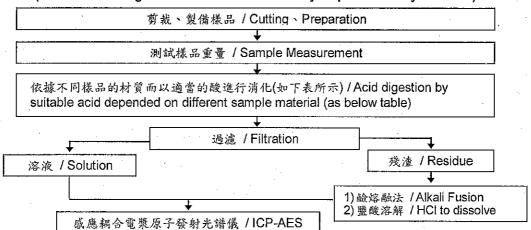
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> 根據以下的流程圖之條件,樣品已完全溶解。 / These samples were dissolved totally by pre-conditioning method according to below flow chart.

- 測試人員:王志瑋 / Technician: JR Wang
- 測試負責人:張啟興 / Supervisor: Troy Chang

元素以 ICP-AES 分析的消化流程圖 (Flow Chart of digestion for the elements analysis performed by ICP-AES)



鋼,銅,鋁,焊錫 / Steel, copper, aluminum, solder	王水,硝酸,鹽酸,氫氟酸,雙氧水/
· · · · · · · · · · · · · · · · · · ·	Aqua regia, HNO₃, HCl, HF, H₂O₂
玻璃 / Glass	硝酸,氫氟酸 / HNO ₃ /HF
金,鉑,鈀,陶瓷 / Gold, platinum, palladium, ceramic	王水 / Aqua regia
銀 / Silver	硝酸 / HNO ₃
塑膠 / Plastic	硫酸,雙氧水,硝酸,鹽酸 / H ₂ SO ₄ , H ₂ O ₂ , HNO ₃ , HCl
其他 / Others	加入適當的試劑至完全溶解 / Added appropriate reagent to total digestion

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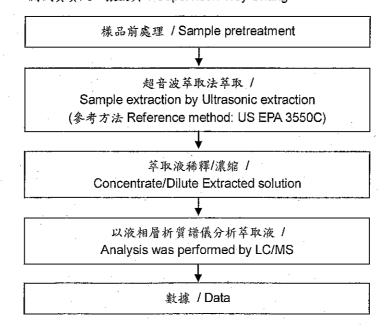
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全氟辛酸/全氟辛烷磺酸分析流程圖 / Analytical flow chart - PFOA/PFOS

- 測試人員:涂雅苓 / Technician: Yaling Tu
- 測試負責人:張啟興 / Supervisor: Troy Chang



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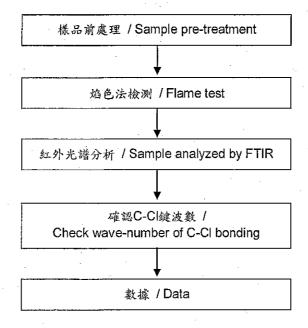
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聚氯乙烯物質判定分析流程圖 / Analysis flow chart - PVC

- 測試人員: 涂雅苓 / Technician: Yaling Tu
- 測試負責人:張啟興 / Supervisor: Troy Chang



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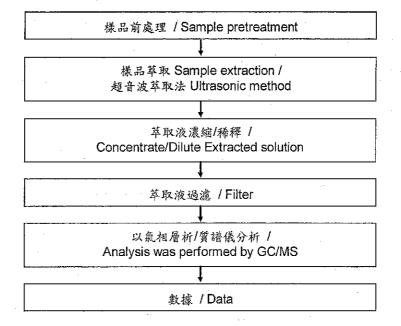
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六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD

測試人員:涂雅苓 / Technician: Yaling Tu

測試負責人:張啟興 / Supervisor: Troy Chang



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鹵素分析流程圖 / Analytical flow chart - Halogen

- 測試人員:陳恩臻 / Technician: Rita Chen
- 測試負責人:張啟興 / Supervisor: Troy Chang

樣品前處理/分樣 / Sample pretreatment/separation 秤重及將樣品放入樣品槽中 / Weighting and putting sample in cell 燃燒彈/吸收 Oxygen Bomb Combustion / Absorption 稀釋至固定體積 / Dilution to fixed volume 離子層析儀分析 / Analysis was performed by IC

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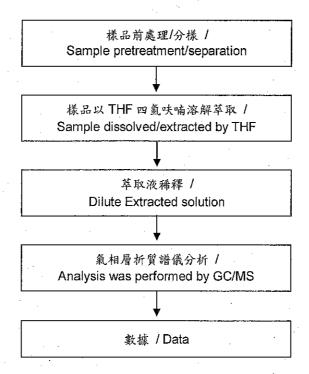
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可塑劑分析流程圖 / Analytical flow chart - Phthalate

測試人員:徐毓明 / Technician: Andy Shu

測試負責人:張啟興 / Supervisor: Troy Chang

【測試方法/Test method: IEC 62321-8】



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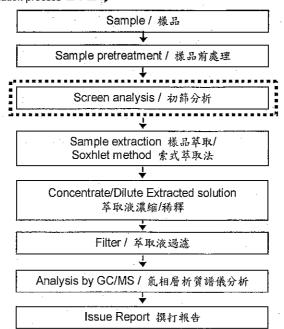
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多溴聯苯/多溴聯苯醚分析流程圖 / Analytical flow chart - PBB/PBDE

- 測試人員:涂雅苓 / Technician: Yaling Tu
- 測試負責人:張啟興 / Supervisor: Troy Chang

初次測試程序 / First testing process -選擇性篩檢程序 / Optional screen process **** 確認程序 / Confirmation process _ . _ . _ .



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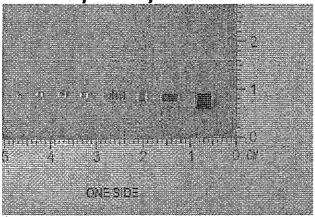
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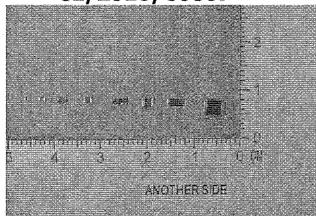
* 照片中如有箭頭標示,則表示為實際檢測之樣品/部位. *

(The tested sample / part is marked by an arrow if it's shown on the photo.)

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** 報告結尾 (End of Report) **

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